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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	8MHz
Connectivity	LINbus, SIO, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	27
Program Memory Size	24KB (24K x 8)
Program Memory Type	FLASH
EEPROM Size	· ·
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.2V ~ 5.5V
Data Converters	
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f212g5snfp-w4

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

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R8C/2G Group RENESAS MCU

1. Overview

1.1 Features

The R8C/2G Group of single-chip MCUs incorporates the R8C/Tiny Series CPU core, employing sophisticated instructions for a high level of efficiency. With 1 Mbyte of address space, and it is capable of executing instructions at high speed. In addition, the CPU core boasts a multiplier for high-speed operation processing. Power consumption is low, and the supported operating modes allow additional power control. These MCUs also use an anti-noise configuration to reduce emissions of electromagnetic noise and are designed to withstand EMI. Integration of many peripheral functions, including multifunction timer and serial interface, reduces the number of system components.

1.1.1 Applications

Electric power meters, electronic household appliances, office equipment, audio equipment, consumer equipment, etc.

1.1.2 Specifications

Table 1.1 outlines the Specifications for R8C/2G Group.



Table 1.2

Current of Apr. 2008

1.2 Product List

Product List for R8C/2G Group

Table 1.2 lists Product List for R8C/2G Group, Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/2G Group.

Part No.	ROM Capacity	RAM Capacity	Package Type	Remarks
R5F212G4SNFP	16 Kbytes	512 bytes	PLQP0032GB-A	N version
R5F212G5SNFP	24 Kbytes	1 Kbytes	PLQP0032GB-A	
R5F212G6SNFP	32 Kbytes	1 Kbytes	PLQP0032GB-A	
R5F212G4SDFP	16 Kbytes	512 bytes	PLQP0032GB-A	D version
R5F212G5SDFP	24 Kbytes	1 Kbytes	PLQP0032GB-A	
R5F212G6SDFP	32 Kbytes	1 Kbytes	PLQP0032GB-A	

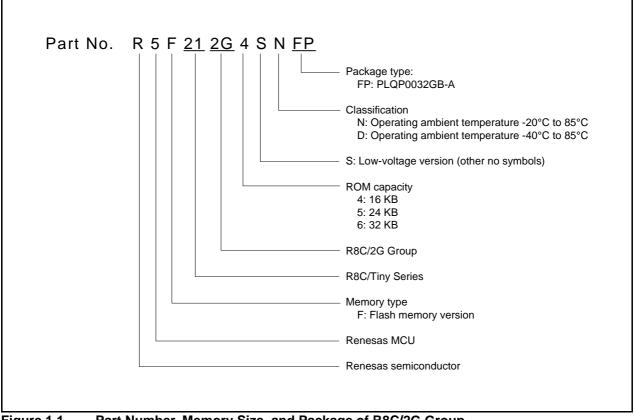


Figure 1.1 Part Number, Memory Size, and Package of R8C/2G Group

RENESAS

1.3 Block Diagram

Figure 1.2 shows a Block Diagram.

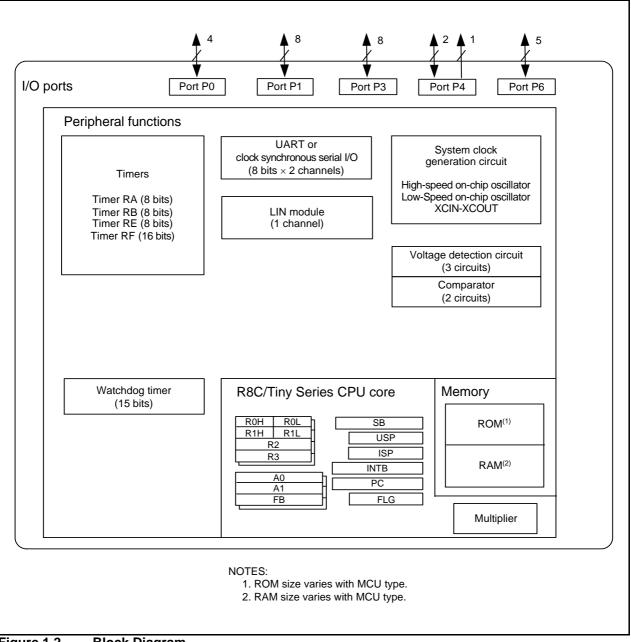
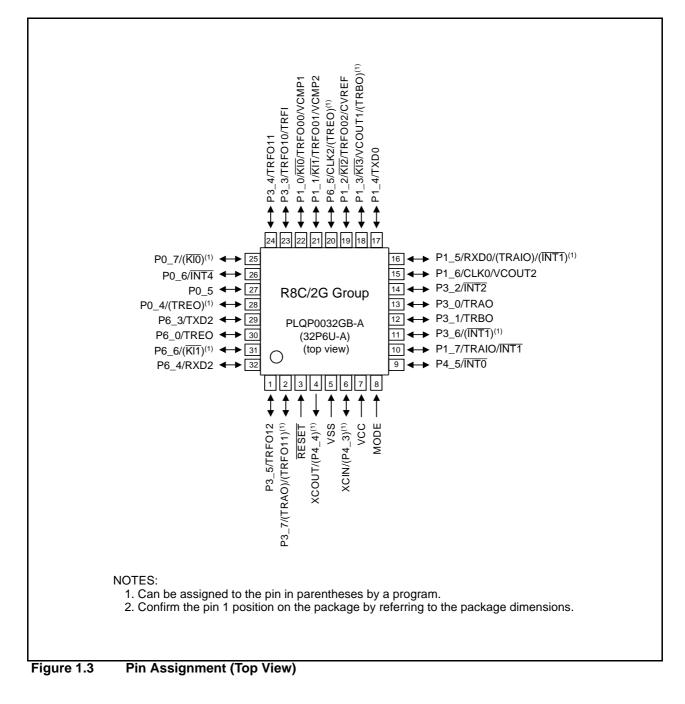


Figure 1.2 Block Diagram

RENESAS

1.4 Pin Assignment

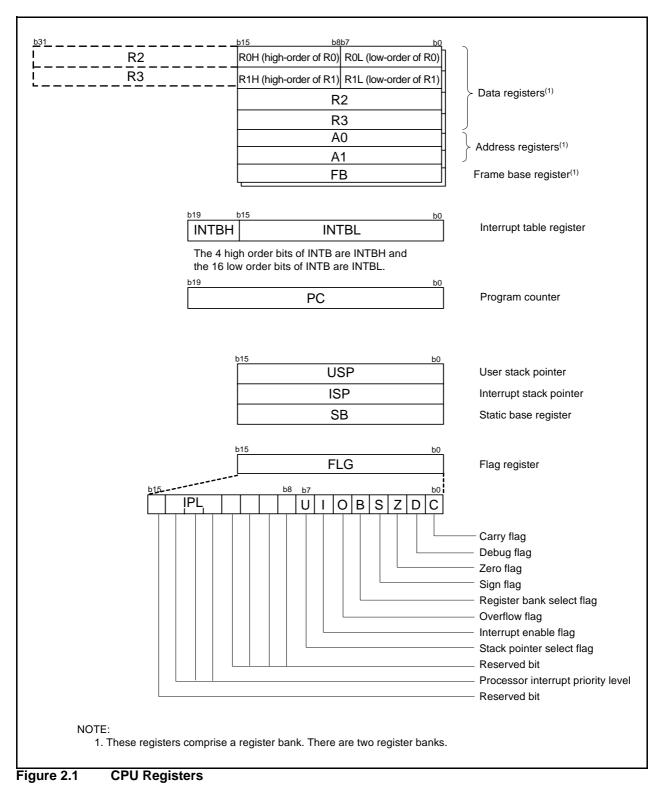
Figure 1.3 shows Pin Assignment (Top View). Table 1.3 outlines the Pin Name Information by Pin Number.





2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.



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2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 to be used as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP, and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.



2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupt are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1. The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.

Special Function Registers (SFRs) 4.

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.12 list the special function registers.

Address	Register	Symbol	After reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01011000b
0007h	System Clock Control Register 1	CM1	00h
0008h			
0009h			
000Ah	Protect Register	PRCR	00h
000Bh			
000Ch	System Clock Select Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00X11111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h	1 · ~		00h
0012h			00h
0013h	Address Match Interrupt Enable Register	AIER	00h
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h	· · ·		00h
0016h			00h
0017h			
0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h
	, i i i i i i i i i i i i i i i i i i i		1000000b ⁽²⁾
001Dh			
001Eh			
001Fh			
0020h	High-Speed On-Chip Oscillator Control Register 0	HRA0	00h
0021h	High-Speed On-Chip Oscillator Control Register 1	HRA1	When Shipping
0022h	High-Speed On-Chip Oscillator Control Register 2	HRA2	00h
0023h			
0024h			
0025h			
0026h			
0027h			
0028h	Clock Prescaler Reset Flag	CPSRF	00h
0029h	High-Speed On-Chip Oscillator Control Register 4	FRA4	When Shipping
002Ah			
002Bh	High-Speed On-Chip Oscillator Control Register 6	FRA6	When Shipping
002Ch		-	
002Dh			
002Eh	BGR Trimming Auxiliary Register A	BGRTRMA	When Shipping
002Fh	BGR Trimming Auxiliary Register B	BGRTRMB	When Shipping

Table 4.1 SFR Information (1)⁽¹⁾

X: Undefined NOTES:
1. The blank regions are reserved. Do not access locations in these regions.
2. The CSPROINI bit in the OFS register is set to 0.

Address	Register	Symbol	After reset
0030h			
0031h	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
0032h	Voltage Detection Register 2 ⁽²⁾	VCA2	00h ⁽³⁾ 00100000b ⁽⁴⁾
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register ⁽⁵⁾	VW1C	00001010b
0037h	Voltage Monitor 2 Circuit Control Register ⁽⁵⁾	VW2C	0000010b
0038h	Voltage Monitor 0 Circuit Control Register ⁽²⁾	VW0C	1000X010b ⁽³⁾ 1100X011b ⁽⁴⁾
0039h			
003Ah			
003Bh	Voltage Detection Circuit External Input Control Register	VCAB	00h
003Ch	Comparator Mode Register	ALCMR	00h
003Dh	Voltage Monitor Circuit Edge Select Register	VCAC	00h
003Eh	BGR Control Register	BGRCR	00h
003Fh	BGR Trimming Register	BGRTRM	When Shipping
0040h			
0041h	Comparator 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0042h	Comparator 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0043h			
0044h			
0045h			
0046h			
0047h			
0048h			
0049h		70510	20000000
004Ah	Timer RE Interrupt Control Register	TREIC	XXXXX000b
004Bh	UART2 Transmit Interrupt Control Register	S2TIC	XXXXX000b
004Ch	UART2 Receive Interrupt Control Register	S2RIC	XXXXX000b
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh			
004Fh	Ormana Alatamat Oratal Draitea	OMPAIO	VVVVV000k
0050h	Compare 1 Interrupt Control Register UART0 Transmit Interrupt Control Register	CMP1IC S0TIC	XXXXX000b XXXXX000b
0051h 0052h		SORIC	
0052h	UART0 Receive Interrupt Control Register	SURIC	XXXXX000b
0053h 0054h			
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RA Interrupt Control Register	TRAIC	XXXXX000b
0057h		TRAIC	
0058h	Timer RB Interrupt Control Register	TRBIC	XXXXX000b
0059h	INT1 Interrupt Control Register	INTIC	XX00X000b
005Ah			
005An	Timer RF Interrupt Control Register	TRFIC	XXXXX000b
005Ch	Compare 0 Interrupt Control Register	CMPOIC	XXXXX000b
005Dh	INTO Interrupt Control Register	INTOIC	XX00X000b
005Eh	INT4 Interrupt Control Register	INT4IC	XX00X000b
005Fh	Capture Interrupt Control Register	CAPIC	XXXXX000b
0060h			
0061h			
0062h			
0063h			1
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah			
006Bh			
006Ch		ł	
006Dh			
006Eh			

Table 4.2 SFR Information (2)⁽¹⁾

X: Undefined NOTES:

- . The blank regions are reserved. Do not access locations in these regions. Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect this register. The LVD0ON bit in the OFS register is set to 1 and hardware reset. Power-on reset, voltage monitor 0 reset, or the LVD0ON bit in the OFS register is set to 0 and hardware reset. Software reset, watchdog timer reset, voltage monitor 1 reset, or voltage monitor 2 reset do not affect b2 and b3.
- 1. 2. 3. 4. 5.



Address	Register	Symbol	After reset
0130h			
0131h			
0132h			
0133h			
0134h			1
0135h			
0136h			
0137h			
0138h			
0139h			
013Ah			1
013Bh			
013Ch			1
013Dh			
013Eh			1
013Fh			<u> </u>
0140h			ł
0140h			ł
0141h 0142h			
0142h 0143h			
0143h			
014411 0145h			ł
0145h			
0146h			<u> </u>
0147h			
0149h			
0143h			
014An			
014Bh			
014Dh			
014Dh			
014En			
014FI1 0150h			
0151h 0152h			
0153h			
0154h 0155h			
0156h			
0157h			
0158h			
0159h			
015Ah			
015Bh			
015Ch			
015Dh			
015Eh			
015Fh			
0160h	UART2 Transmit/Receive Mode Register	U2MR	00h
0161h	UART2 Bit Rate Register	U2BRG	XXh
0162h	UART2 Transmit Buffer Register	U2TB	XXh
0163h			XXh
0164h	UART2 Transmit/Receive Control Register 0	U2C0	00001000b
0165h	UART2 Transmit/Receive Control Register 1	U2C1	00000010b
0166h	UART2 Receive Buffer Register	U2RB	XXh
0167h			XXh
0168h			
0169h			
016Ah			
016Bh			
OTODIT			1
016Ch			
016Ch 016Dh			
016Ch			

SFR Information (6)⁽¹⁾ Table 4.6

X: Undefined NOTE: 1. The blank regions are reserved. Do not access locations in these regions.

Address	Register	Symbol	After reset
0170h			
0171h			
0172h			
0173h			
0174h			
0175h			
0176h			
0177h			
0178h			
0179h			
017Ah			
017Bh			
017Ch			
017Dh			
017Eh			
017Fh			
0180h			
0181h			
0182h			
0183h			
0184h			
0185h			
0186h			
0187h			
0188h			
0189h 018Ah			
018Ah			
018Bh 018Ch			
018Dh			
018Dh			
018Eh			
018111 0190h			
01901 0191h			
0192h			
0193h			
0194h			
0195h			
0196h			
0197h			
0198h			
0199h			
019Ah			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			
01ADh			
01AEh			
01AFh			
Vulladafiaad			

SFR Information (7)⁽¹⁾ Table 4.7

X: Undefined NOTE: 1. The blank regions are reserved. Do not access locations in these regions.



Address Register Symbol 0230h	After reset
0231h	
0232h	
0233h 0234h 0235h 0237h 0238h 0239h 0239h 0239h </td <td></td>	
0234h 0235h 0237h 0238h 0239h 0238h 0238h 0238h 0238h 0238h 0238h 0238h 0238h 0238h 0239h 0239h 0239h 0239h 0240h 0241h 0242h 0244h 0244h 0244h 0244h 0244h 0244h 0244h <td< td=""><td></td></td<>	
0235h 0237h 0238h 0239h 0239h 0238h 0238h 0238h 0238h 0238h 0238h 0232h 0232h 0232h 0232h 0232h 0232h 0232h 0240h 0241h 0242h 0243h 0244h <	
0236h 0237h 0238h 0239h 0238h 023Ah	
0237h 0238h 0239h 0238h </td <td></td>	
0238h 0239h 023Ah 023Bh 023Ch 023Dh 023Bh 023Dh 023Fh 023Fh 0240h 0241h 0242h 0243h 0244h 0244h 0248h 0248h 0248h 0248h 0244h 0245h 0246h 0246h 0246h 0246h 0244h 0244h 0244h 0244h 0244h 0244h 0244h 0244h 0245h 0245h <td< td=""><td></td></td<>	
0239h 023Ah 023Bh 023Ch 023Dh 023Fh 023Fh 0240h 0241h 0242h 0243h 0244h 0244h 0248h 0248h 0248h 0248h 0242h 0248h 0248h 0248h 0242h 0242h 0244h 0242h 0242h 0242h 0242h <td< td=""><td></td></td<>	
023Ah	
023Bh 023Ch 023Dh 023Fh 0240h 0241h 0242h 0243h 0243h 0243h 0244h 0244h 0244h 0244h 0248h	
023Ch	
023Dh 023Fh 024h 0240h 0241h 0242h 0243h 0243h 0244h 0248h 0248h 0244h 0244h 0242h 0242h 0242h 0242h 0242h 0242h 0242h 0242h 0250h	
023Eh	
023Fh 0240h 0241h 0242h 0243h 0244h 0244h 0244h 0244h 0244h 0244h 0246h 0247h 0248h 0248h 0248h 0248h 0248h 0248h 0248h 0248h 0248h 0242h 0242h 0242h 0242h 0242h 0250h <td< td=""><td></td></td<>	
0240h 0241h 0242h 0243h 0243h 0244h 0245h 0245h 0245h 0245h 0245h 0245h 0248h 024Bh 024Ch 024Dh 024Fh 0250h 0251h	
0241h 0242h 0243h 0244h 0245h 0246h 0248h 0242h 0242h 0242h 0242h 0242h 0242h 0242h 0250h 0251h	
0242h 0243h 0244h 0245h 0246h 0247h </td <td></td>	
0243h 0244h 0245h 0246h 0247h 0248h 0248h 0248h 0248h 0248h 0248h 024Ah 024Ch 024Eh 024Fh 0250h 0251h	
0244h	
0245h 0246h 0247h 0248h 0249h	
0246h	
0247h 0248h 0249h 024Ah 024Bh 024Ch 024Dh 024Eh 024Fh 024Fh 0250h 0251h	
0248h 0249h 024Ah 024Bh 024Bh 024Ch 024Dh 024Eh 024Fh 0250h 0251h	
0249h 024Ah 024Bh 024Ch 024Dh 024Eh 024Fh 0250h 0251h	
024Ah	
024Bh 024Ch 024Dh 024Eh 024Fh 0250h 0251h	
024Ch 024Dh 024Eh 024Fh 0250h 0251h	
024Dh 024Eh 024Fh 0250h 0250h 0251h	
024Eh 024Fh 0250h 0251h	
024Fh 0250h 0251h	
0250h 0251h	
0251h	
0251n	
02526	
0252h	
0253h	
0254h	
0255h	
0256h	
0257h	
0258h	
0259h	
025Ah	
025Bh	
025Ch	
025Dh	
025Eh	
025Fh	
0260h	
0261h	
0262h	
0263h	
0264h	
0265h	
0266h	
0267h	
0268h	
0269h	
026Ah	
026Bh	
026Ch	
026Dh	
026Eh	
026Fh	

SFR Information (10)⁽¹⁾ Table 4.10

X: Undefined NOTE: 1. The blank regions are reserved. Do not access locations in these regions.

Symbol	Parameter	Condition	Standard			Unit
Symbol	Faranieler	Condition	Min.	Тур.	Max.	Unit
Vdet0	Voltage detection level		2.2	2.3	2.4	V
_	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	_	0.9	-	μA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		-	-	300	μS
Vccmin	MCU operating voltage minimum value		2.2	-	-	V

Table 5.4 Voltage Detection 0 Circuit Electrical Characteristics

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and T_{opr} = -20 to 85°C (N version) / -40 to 85°C (D version).

2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.

Table 5.5 Voltage Detection 1 Circuit Electrical Characteristics

Svmbol	Parameter	Condition	Standard			Unit
Symbol	Farameter	Condition	Min.	Тур.	Max.	Unit
Vdet1	Voltage detection level ⁽⁴⁾		2.70	2.85	3.00	V
-	Voltage monitor 1 interrupt request generation time ⁽²⁾		-	40	-	μS
-	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	-	0.6	-	μA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	-	100	μS

NOTES:

- 1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).
- 2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
- 4. This parameter shows the voltage detection level when the power supply drops. The voltage detection level when the power supply rises is higher than the voltage detection level when the power supply drops by approximately 0.1 V.

Table 5.6 Voltage Detection 2 Circuit Electrical Characteristics

Symbol	Parameter	Condition	Standard			Unit
Symbol	Farameter	Condition	Min.	Тур.	Max.	Unit
Vdet2	Voltage detection level		3.3	3.6	3.9	V
-	Voltage monitor 2 interrupt request generation time ⁽²⁾		-	40	-	μS
-	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	_	0.6	-	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	-	100	μS

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and Topr = -20 to 85°C (N version) / -40 to 85°C (D version).

2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes $\mathsf{V}_{\mathsf{det2}}$

3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

Symbol	Parameter	Condition		Unit		
Symbol	Falanielei	Condition	Min.	Тур.	Max.	Onit
Vref	Internal reference voltage	Vcc = 2.2 V to 5.5 V, Topr = 25° C	1.15	1.25	1.35	V
		$V_{CC} = 2.2 V \text{ to } 5.5 V,$ $T_{opr} = -40 \text{ to } 85^{\circ}\text{C}$	_	1.25	-	V
Vcref	External input reference voltage	Vcc = 2.2 V to 4.0 V	0.5	-	Vcc - 1.1	V
		Vcc = 4.0 V to 5.5 V	0.5	-	Vcc - 1.5	
Vcin	External comparison voltage input range		-0.3	_	Vcc + 0.3	V
Vofs	Input offset voltage		-	20	120	mV
Tcrsp	Response time		-	4	-	μS

Table 5.8 Comparator Electrical Characteristics

NOTE:

1. The measurement condition is $T_{opr} = -20$ to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.

Table 5.9 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard		Unit
Symbol	Falanielei	Condition	Min.	Тур.	Max.	Unit
fOCO-F	High-speed on-chip oscillator frequency	Vcc = 4.75 V to 5.25 V	7.76	8	8.24	MHz
	temperature • supply voltage dependence	$T_{opr} = 0$ to $60^{\circ}C^{(2)}$				
		Vcc = 2.7 V to 5.5 V	7.68	8	8.32	MHz
		Topr = -20 to $85^{\circ}C^{(2)}$				
		Vcc = 2.7 V to 5.5 V	7.44	8	8.32	MHz
		$T_{opr} = -40$ to $85^{\circ}C^{(2)}$				
		Vcc = 2.2 V to 5.5 V	7.04	8	8.96	MHz
		Topr = -20 to $85^{\circ}C^{(3)}$				
		Vcc = 2.2 V to 5.5 V	6.8	8	9.2	MHz
		Topr = -40 to $85^{\circ}C^{(3)}$				

NOTES:

1. The measurement condition is Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

2. These standard values show when the HRA1 register is set to the value before shipment and the HRA2 register is set to 00h.

3. These standard values show when the correction value in the FRA6 register is written into the HRA1 register.

Table 5.10 Low-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition		Standard			
Symbol	Falanetei	Condition	Min.	Тур.	Max.	Unit	
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz	
-	Oscillation stability time		-	10	100	μS	
-	Self power consumption at oscillation	VCC = 5.0 V, Topr = $25^{\circ}C$	_	15	-	μA	

NOTE:

1. Vcc = 2.2 to 5.5 V, Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

Table 5.11 Power Supply Circuit Timing Characteristics

Symbol	Parameter	Condition	Standard			Unit
Symbol	Falanetei	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	-	2000	μs
td(R-S)	STOP exit time ⁽³⁾		-	-	150	μs

NOTES:

1. The measurement condition is Vcc = 2.2 to 5.5 V and $T_{opr} = 25^{\circ}C$.

2. Waiting time until the internal power supply generation circuit stabilizes during power-on.

3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



Symbol	Parameter	Condition	Standard			Unit	
Symbol	Falameter		Min.	Тур.	Max.	Unit	
Vон			Iон = -5 mA	Vcc - 2.0	-	Vcc	V
			Іон = -200 μА	Vcc - 0.5	-	Vcc	V
Vol	Output "L" voltage		IOL = 5 mA	-	-	2.0	V
			ΙΟL = 200 μΑ	-	-	0.45	V
Vt+-Vt-	Hysteresis	INT0, INT1, INT2, INT4, KI0, KI1, KI2, KI3, RXD0, RXD2, CLK0, CLK2		0.1	0.5	_	V
		RESET		0.1	1.0	-	V
Ін	Input "H" current		VI = 5 V, Vcc = 5 V	-	-	5.0	μΑ
lı∟	Input "L" current		VI = 0 V, Vcc = 5 V	-	_	-5.0	μA
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 5 V	30	50	167	kΩ
RfXCIN	Feedback resistance	XCIN		-	18	-	MΩ
Vram	RAM hold voltage		During stop mode	2.0	-	-	V

Table 5.12 Electrical Characteristics (1) VCC = 5 V	Table 5.12	Electrical Characteristics (1) [Vcc = 5 V]
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NOTE: 1. Vcc = 4.2 to 5.5 V at T_{opr} = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

Table 5.19	Electrical Characteristics (4) [Vcc = 3 V]
	(Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

0	Doromotor				Standar	d	
Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
Icc	Power supply current (Vcc = 2.7 to 3.3 V)	High-speed on-chip oscillator mode	High-speed on-chip oscillator on = 8 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	5	-	mA
	Single-chip mode, output pins are open, other pins are Vss		High-speed on-chip oscillator on = 8 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	2	-	mA
		Low-speed on-chip oscillator mode	High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1	-	130	300	μA
		Low-speed clock mode	High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) FMR47 = 1	-	130	300	μA
			High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) Program operation on RAM Flash memory off, FMSTP = 1	-	30	_	μA
		Wait mode	High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	25	70	μA
			High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	23	55	μA
			High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 BGR trimming circuit disabled (BGRCR0 = 1)	-	3.8	_	μA
			High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 BGR trimming circuit disabled (BGRCR0 = 1)	_	2	-	μA
			High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 BGR trimming circuit enabled (BGRCR0 = 0)	-	8	-	μA
			High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 BGR trimming circuit enabled (BGRCR0 = 0)	-	6	-	μA
		Stop mode	XCIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 BGR trimming circuit disabled (BGRCR0 = 1)	_	0.7	3	μA
			XCIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 BGR trimming circuit disabled (BGRCR0 = 1)	-	1.1	-	μA
			XCIN clock off, Topr = 25° C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 BGR trimming circuit enabled (BGRCR0 = 0)	_	5	7	μA
			XCIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 BGR trimming circuit enabled (BGRCR0 = 0)	-	5.5	_	μA

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Timing requirements (Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C) [Vcc = 3 V]

Table 5.20XCIN Input

Symbol	Parameter		Standard		
Symbol			Max.	Unit	
tc(XCIN)	XCIN input cycle time		-	μS	
tWH(XCIN)	XCIN input "H" width		-	μS	
twl(xcin)	XCIN input "L" width		-	μS	

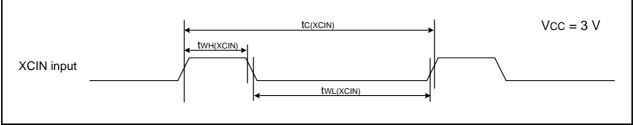


Figure 5.7 XCIN Input Timing Diagram when Vcc = 3 V

Table 5.21 TRAIO Input

Symbol	Parameter		Standard		
Symbol	Falanielei	Min.	Max.	Unit	
tc(TRAIO)	TRAIO input cycle time		-	ns	
twh(traio)	TRAIO input "H" width		-	ns	
twl(traio)	TRAIO input "L" width		-	ns	

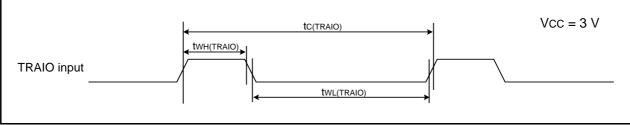


Figure 5.8 TRAIO Input Timing Diagram when Vcc = 3 V

Cumbal	Parameter	Condition	Standard			Unit	
Symbol	Falameter		Min.	Тур.	Max.	Unit	
Vон	Output "H" voltage		Іон = –1 mA	Vcc - 0.5	-	Vcc	V
Vol	Output "L" voltage		IOL = 1 mA	-	-	0.5	V
Vt+-Vt-	Hysteresis <u>INT0</u> , <u>INT1</u> , <u>INT2</u> , <u>INT4</u> , <u>KI0</u> , <u>KI1</u> , <u>KI2</u> , <u>KI3</u> , RXD0, RXD2, CLK0, CLK2			0.05	0.3	-	V
		RESET		0.05	0.15	-	V
Ін	Input "H" current		VI = 2.2 V	-	-	4.0	μΑ
lı∟	Input "L" current		VI = 0 V	-	-	-4.0	μA
Rpullup	Pull-up resistance		VI = 0 V	100	200	600	kΩ
Rfxcin	Feedback resistance	XCIN		-	35	_	MΩ
Vram	RAM hold voltage		During stop mode	1.8	-	_	V

Table 5.24	Electrical Characteristics (5) [Vcc = 2.2 V	1
		ι.

NOTE: 1. Vcc = 2.2 V at T_{opr} = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.

Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Technology website.

